

FEATURES :

- SIP Packages
- High Efficiency 91% @5.0Vin 3.3V ,Full Load
93% @12.0Vin 3.3V ,Full Load
- Customized Solutions Available
- Operating Temperature From -40°C To +85°C
- 3 Years Warranty
- Input Under-Voltage Lockout
- Input Range 2.4VDC To 5.5VDC, 8.3VDC To 14VDC
- Output Current Up To 6A
- Output Voltage Programmable From 0.75VDC To 3.3VDC,
0.75VDC To 5VDC Via External Resistor

YUAN DEAN SCIENTIFIC



Specifications typical at TA=25°C, nominal input voltage and rated output current unless otherwise specified

Part Number	ON/OFF Logic	Input Range	Output Voltage	Output Current		Efficiency (%) 3.3Vdc @6A
				Min. Load	Max. Load	
02D-05-06S	Positive (option) Negative (standard)	2.4 ~ 5.5Vdc Vin(min) = Vo(Set)+0.5	0.75 ~3.3Vdc	0A	6A	91% @5.0Vin
02D-12-06S						

Input Specifications

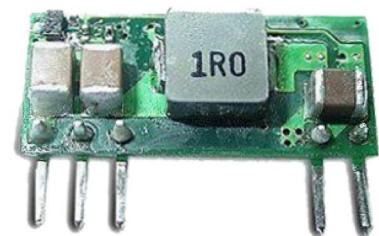
Parameters	Conditions	Min	Typ	Max	Units
Voltage Tolerance	05 Series Vo(set)	2.4	5	5.5	Vdc
	12 Series Vo(set)	8.3	12	14	
Input Current	Vin=Vin(min); Io=Io(max)			6	A
Input Filter (Note4)	C filter				
No Load Current	Vo(set)=0.75Vdc	20	@Vin=5		mA
	Vo(set)=0.75Vdc	19	@Vin=12		mA
	Vo(set)=3.3Vdc	45	@Vin=5		mA
	Vo(set)=5.0Vdc	100	@Vin=12		mA
Under Voltage Lockout	Start-up Voltage	2.2@Vin= 5			V
	Shutdown Voltage	4.5@Vin=12			V
		2.0 @Vin=5			V
		3.8 @Vin=12			V

Input reflected ripple current 5~20MHz, 1uH source impedance:35mAp-p

DC-DC Converter**02D-6A SERIES**

**Non-Isolated
Single Output**

1.0”*0.4”*0.2”

**Applications**

- Wireless Network
- Telecom/Datacom
- Distributed Power Architectures
- Industry Control System
- Semiconductor Equipment
- Microprocessor Power Applications

www.yds.com.tw



TEL : 886-6-3842899 FAX : 886-6-3843288

E-MAIL : ydsweb@yds.com.tw

Rev:0 2018/10/31

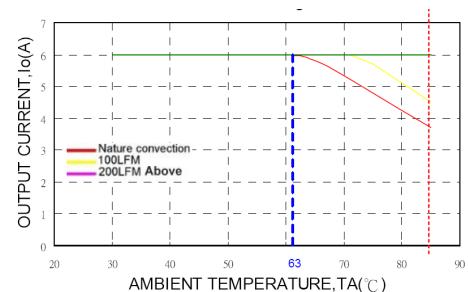
Output Specifications

Parameters	Conditions	Min	Typ	Max	Units
Output current			6		A
Voltage Tolerance	Full load and Vin(min)		± 2		%
Minimum load		0			A
Line Regulation	Vin=Vin (min) to Vin (max) at Full Load		± 0.3		%
Load Regulation	No Load to Full Load		± 0.5		%
Ripple & Noise (Note2)	20MHz bandwidth		60		mVp-p
Dynamic load response (Note 2)	$\Delta I_o / \Delta t = 2.5A/\mu s$, Vin(nom)	Peak deviation	200		mV
	Load change step (25% to 100% or 100% to 25% of $I_o(\text{max})$)	Setting time ($V_o < 10\%$ peak deviation)	25		μs
Dynamic load Response (Note 3)	$\Delta I_o / \Delta t = 2.5A/\mu s$, Vin(nom)	Peak deviation	50		mV
	Load change step (25% to 100% or 100% to 25% of $I_o(\text{max})$)	Setting time ($V_o < 10\%$ peak deviation)	50		μs
Output current limit		220			%
Output short-circuit current	Hiccup, automatic recovery				
External load capacitance	$ESR \geq 1m\Omega$	1000			μF
	$ESR \geq 10m\Omega$	3000			μF
Output voltage overshoot-startup	Vin=Vin(min) to Vin(max);F.L	1			%
Voltage adjustability (see fig.1)	05 Series	0.7525		3.3 @ $V_{in}=5$	V
	12 Series	0.7525		5.0 @ $V_{in}=12$	V

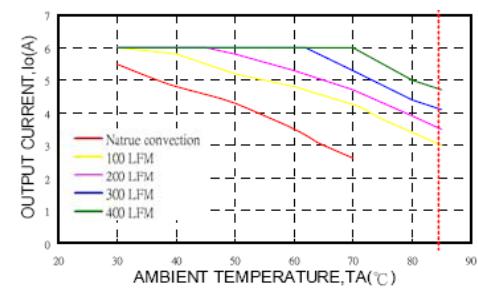
General Specifications

Parameters	Conditions	Min	Typ	Max	Units
Switching Frequency		300			KHz
Isolation voltage		None			
Efficiency		See table			
Dimensions	As figure of marking and dimension				mm
Weight		2.8			g
MTBF (Note 1)	MIL-HDBK-217F	3.247 x 10 ⁶			Hours

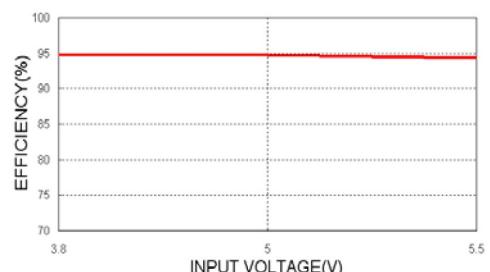
02D-05-06S, Vo=3.3V, Derating Curve



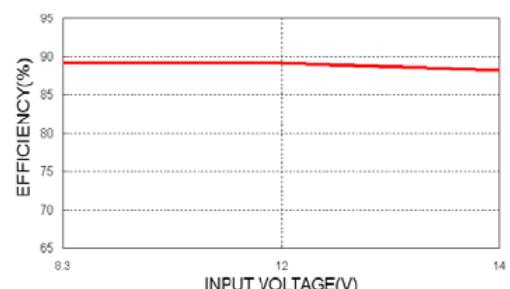
02D-12-06S, Vo=3.3V, Derating Curve



02D-05-06S, Vo=3.3V Efficiency VS Input Voltage



02D-12-06S, Vo=3.3V Efficiency VS Input Voltage



Environmental Specifications

Parameters	Conditions	Min	Typ	Max	Units
Operating temperature range	with derating	-40		85	°C
Storage temperature range	With derating	-55		125	°C
Thermal shock	MIL-STD-810F				
Over temperature protection	135				°C

Feature Specifications

Parameters	Conditions	Min	Typ	Max	Units
Remote ON/OFF					
Positive logic(option)	ON=(Vin-4)<Vr<Vin(Max)			10	uA
	OFF=0V<Vr<0.3V			1	mA
Negative logic(standard)	ON=0V<Vr<0.3V@IIN			10	uA
	OFF=1.5V<Vr<Vin(Max)@IIN			1	mA
Input current of Remote control pin		0.01		1.0	mA
Remote off state input current Nominal Vin			5		mA
Rise time (Time for Vo to rise from 10% to 90% of Vo(set))				6	ms
Turn-on delay time	Case 1 (Note 5)		3		ms
	Case 2 (Note 6)		3		ms

Note :

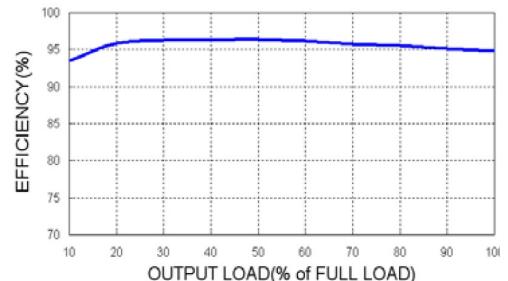
1. MIL-HDBK-217F Notice2 @Ta=25 °C, Full load(Ground, Benign, controlled environment).
2. External with Cout = 1uF ceramic//10uF tantalum capacitors.
3. External with Cout = 2×150uF polymer capacitors.
4. It's necessary to equip the external input capacitors at the input of the module. The capacitors should connect as close as possible to the input terminals that ensuring module stability. The external Cin is 2×150μF low-ESR polymer capacitors // 2×47μF ceramic capacitors at least.
5. Case 1 :On/Off input is set to logic low (module on) and then input power is applied (delay from instant at which Vin=Vin(min) until Vo=10% of Vo(set))
6. Case 2 :Input power is applied for at least one second and then the On/Off input is set to logic low (delay from instant at which Von/off=0.3V until Vo=10% of Vo(set))

CAUTION :

This power module is not internally fused.

An input line fuse must always be used.

02D-05-06S,Vo=3.3V Efficiency VS Output Load



02D-12-06S,Vo=3.3V Efficiency VS Output Load

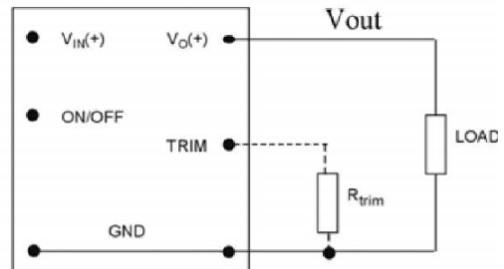
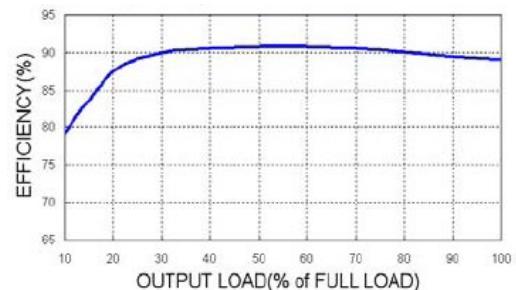
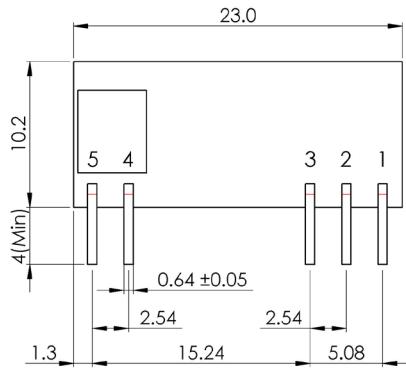


Fig. 1



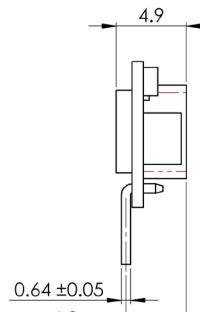
Dimensions

02D-05-06S



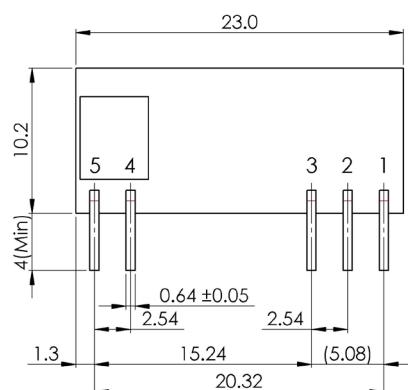
BOTTOM VIEW

Unit : mm
Tolerance : XX.X±0.5 , XX.XX±0.25



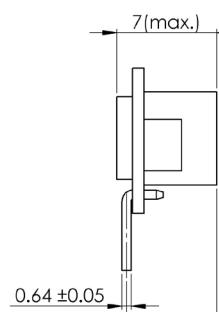
SIDE VIEW

02D-12-06S



BOTTOM VIEW

Unit : mm
Tolerance : XX.X±0.5 , XX.XX±0.25



SIDE VIEW

PIN Assignment

Pin	1	2	3	4	5
Function	+Vout	Trim	GND	+Vin	Remote On/Off

